



Product/Process Change Notice - PCN 21_0023 Rev. -

Analog Devices, Inc. Three Technology Way Norwood, Massachusetts 02062-9106

This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title: OP4177 Die Revision, Wafer Fabrication Process Change, Conversion to Copper Wire & Assembly Site Transfer

Publication Date: 16-Feb-2021

Effectivity Date: 21-May-2021 *(the earliest date that a customer could expect to receive changed material)*

Revision Description:
Initial Release.

Description Of Change:

- 1) Wafer fabrication process is changing from HVBP1 to XFCB40
- 2) Layout has been revised to accommodate the fabrication process change. This includes the transistor layout, rerouting of circuitry and bond pad location
- 3) Polyimide thickness is increasing from 5um to 17um
- 4) Conversion of bond wire material from Gold to Copper
- 5) Assembly site is migrating from Amkor Philippines to ASE Chung-Li Taiwan

Reason For Change:

Migrating the OP4177 to a newer process and assembly site to improve capacity utilization to ensure longevity of the supply chain.

Impact of the change (positive or negative) on fit, form, function & reliability:

The new material will meet or exceed the performance of the existing material. There will be no changes to form, fit, function and reliability.

Product Identification *(this section will describe how to identify the changed material)*

Cut-Over Date Code provided upon request.

Summary of Supporting Information:

Qualification has been performed per Industry Standard Test Methods. See attached Qualification Results Summary.

Comments

The old die will be available with gold wire as the OP4177CARZ & OP4177CARZ-R7

Supporting Documents

Attachment 1: Type: Qualification Results Summary

ADI_PCN_21_0023_Rev_-_OP4177_Qualification_Results_Summary.pdf

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:
PCN_Americas@analog.com

Europe:
PCN_Europe@analog.com

Japan:
PCN_Japan@analog.com

Rest of Asia:
PCN_ROA@analog.com

Appendix A - Affected ADI Models

Added Parts On This Revision - Product Family / Model Number (3)

OP4177 / OP4177ARZ

OP4177 / OP4177ARZ-REEL

OP4177 / OP4177ARZ-REEL7

Appendix B - Revision History

Rev	Publish Date	Effectivity Date	Rev Description
Rev. -	16-Feb-2021	21-May-2021	Initial Release.

Analog Devices, Inc.

DocId:8426 Parent DocId:8235 Layout Rev:7